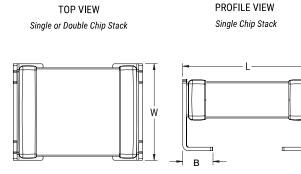


## C2220C335K3N1C7186 KPS SMD Comm X8L HT150C, Ceramic, 3.3 uF, 10%, 25 VDC, X8L, 2220-1



General Information	
Series	KPS SMD Comm X8L HT150C
Style	Stacked Chip
Description	SMD, MLCC, Stacked, Single Chip, High Temperature
Features	High Temperature
RoHS	Yes
Termination	Tin
AEC-Q200	No
Typical Component Weight	410 mg
Chip Size	2220-1
Shelf Life	78 Weeks
MSL	1

Click here for the 3D model.

Dimensions	
L	6mm +/-0.5mm
W	5mm +/-0.5mm
т	3.5mm +/-0.30mm
В	1.6mm +/-0.3mm
Packaging Specifications	

Packaging Packaging Quantity T&R, 180mm, Plastic Tape 300

Specifications	
Capacitance	3.3 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8L
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	+15% (-55C to +125C), +15/-40% (125C to 150C), 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	151.5 MOhms

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